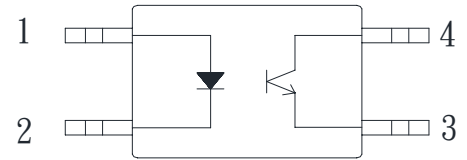


● Description

The KT101T series consist of an infrared emitting diode, optically coupled to a phototransistor detector, and is incorporated in a 4 pin LSOP wide body package. It features a high current transfer ratio, low coupling capacitance and high isolation voltage.

● Schematic



- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector

● Features

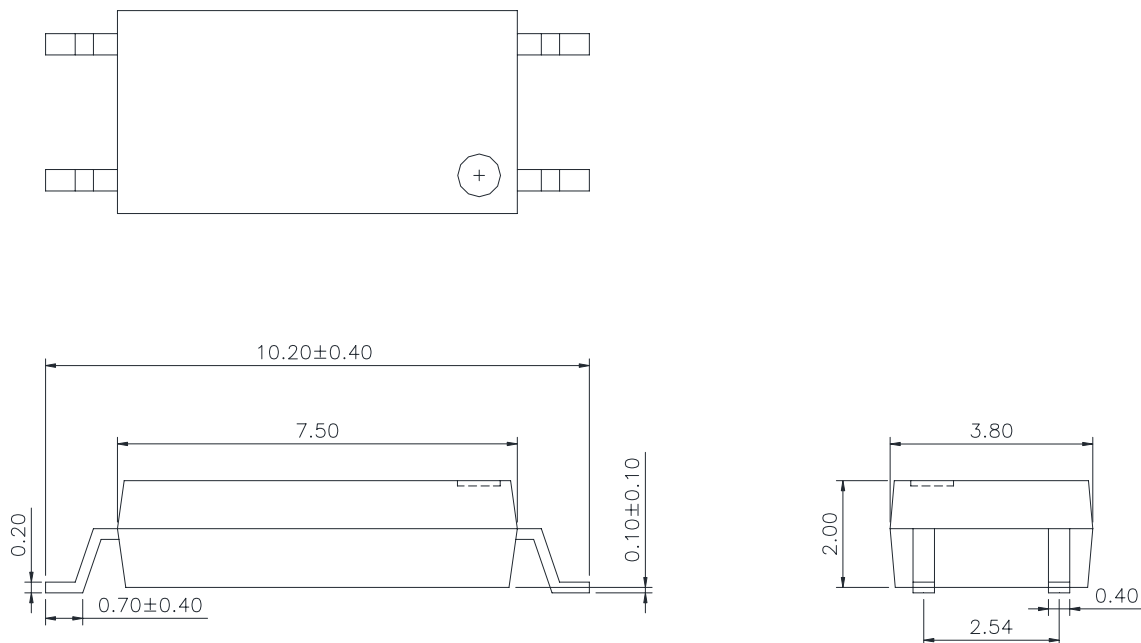
1. Halogen free
2. Pb free and RoHS compliant
3. Temperature range -55°C to 115°C
4. High isolation voltage 5000Vrms
5. Opaque type, SMD low profile 4 lead package
6. Current transfer ratio
(CTR : Min.50% at $I_F=1\text{mA}$ $V_{CE}=5\text{V}$)
7. 8mm outer creepage distance
8. Low coupling capacitance
9. MSL class 1
10. Agency Approvals:
 - UL Approved (No. E169586): UL1577
 - c-UL Approved (No. E169586)
 - VDE Approved (No. 40031267): DIN EN60747-5-5
 - FIMKO Approved: EN60065, EN60950, EN60335, EN60601
 - CQC Approved: GB8898-2011, GB4943.1-2011

● Applications

- Industrial controls
- Programmable controllers
- Switch mode power supplies
- Battery equipment.
- Office machine

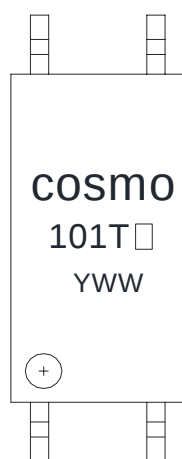
● Outside Dimension

Unit : mm



TOLERANCE : ±0.2mm

● Device Marking



Notes:

cosmo

101T□

YWW

□: CTR rank

Y: Year code / WW: Week code

● Absolute Maximum Ratings

(Ta=25°C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	50	mA
	Peak forward current	I_{FP}	1	A
	Reverse voltage	V_R	6	V
	Power dissipation	P_D	100	mW
Output	Collector-Emitter voltage	V_{CEO}	80	V
	Emitter-Collector voltage	V_{ECO}	7	V
	Collector current	I_C	50	mA
	Collector power dissipation	P_C	150	mW
Total power dissipation		P_{tot}	250	mW
Isolation voltage 1 minute		V_{iso}	5000	Vrms
Operating temperature		T_{opr}	-55 to +115	°C
Storage temperature		T_{stg}	-55 to +125	°C
Soldering temperature 10 seconds		T_{sol}	260	°C

● Electro-optical Characteristics

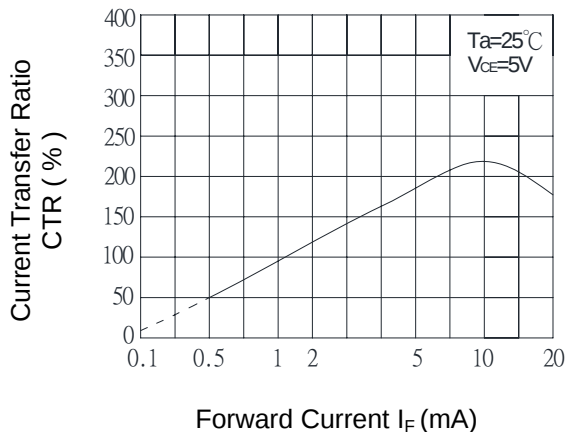
(Ta=25°C)

Parameter		Symbol	Conditions	Min.	Typ.	Max.	Unit
Input	Forward voltage	V_F	$I_F=20mA$	-	1.2	1.4	V
	Reverse current	I_R	$V_R=4V$	-	-	10	uA
	Terminal capacitance	C_t	$V=0, f=1KHz$	-	30	250	pF
Output	Collector dark current	I_{CEO}	$V_{CE}=20V, I_F=0$	-	-	0.1	uA
	Collector-Emitter breakdown voltage	BV_{CEO}	$I_C=0.1mA, I_F=0$	80	-	-	V
	Emitter-Collector breakdown voltage	BV_{ECO}	$I_E=100uA, I_F=0$	7	-	-	V
Transfer characteristics	Current transfer ratio	CTR	$I_F=1mA, V_{CE}=5V$	50	-	600	%
	Collector-Emitter saturation voltage	$V_{CE(sat)}$	$I_F=10mA, I_C=1mA$	-	0.1	0.2	V
	Isolation resistance	Riso	DC500V, 40 to 60%RH	5×10^{10}	10^{11}	-	Ω
	Floating capacitance	C_f	$V=0, f=1MHz$	-	0.6	1.0	pF
	Response time (Rise)	t_r	$V_{CC}=2V, I_C=2mA, R_L=100\Omega$	-	4	-	us
	Response time (Fall)	t_f		-	3	-	us

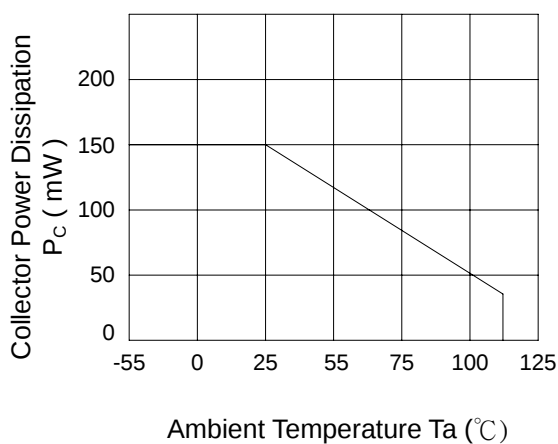
Classification table of current transfer ratio is shown below.

CTR Rank.	CTR (%)
KT101TA	63 TO 125
KT101TB	100 TO 200

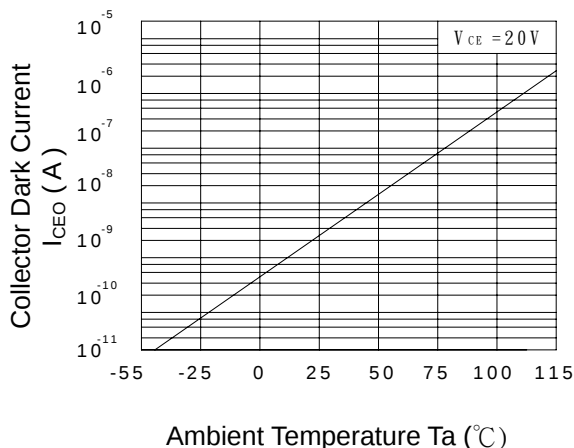
**Fig.1 Current Transfer Ratio
vs. Forward Current**



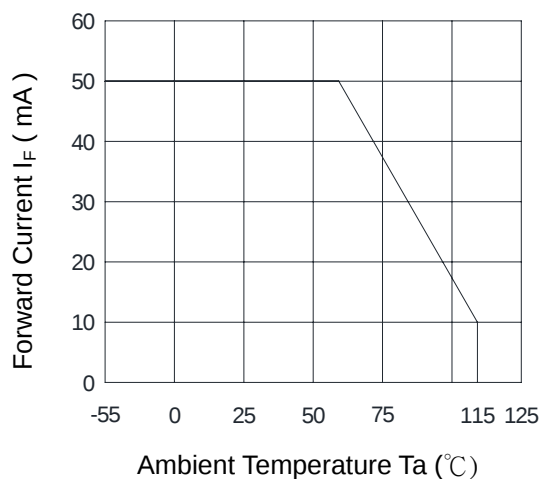
**Fig.2 Collector Power Dissipation
vs. Ambient Temperature**



**Fig.3 Collector Dark Current
vs. Ambient Temperature**



**Fig.4 Forward Current
vs. Ambient Temperature**



**Fig.5 Forward Current
vs. Forward Voltage**

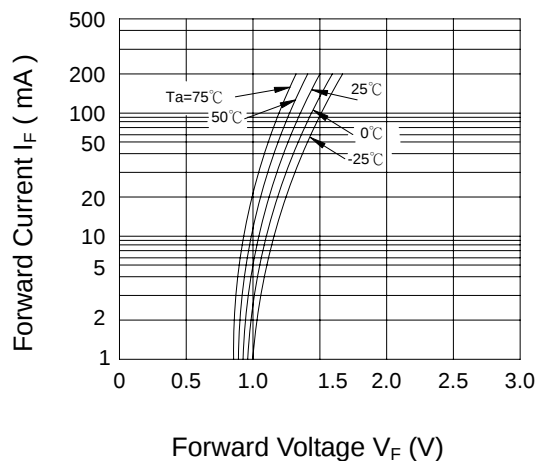


Fig.6 Collector Current vs. Collector-Emitter Voltage

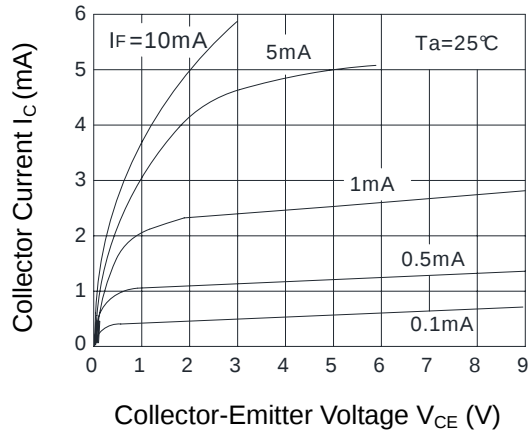


Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

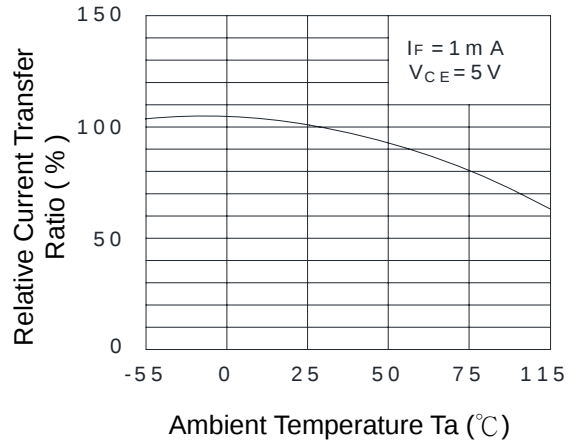


Fig.8 Collector-Emitter Saturation Voltage vs. Ambient Temperature

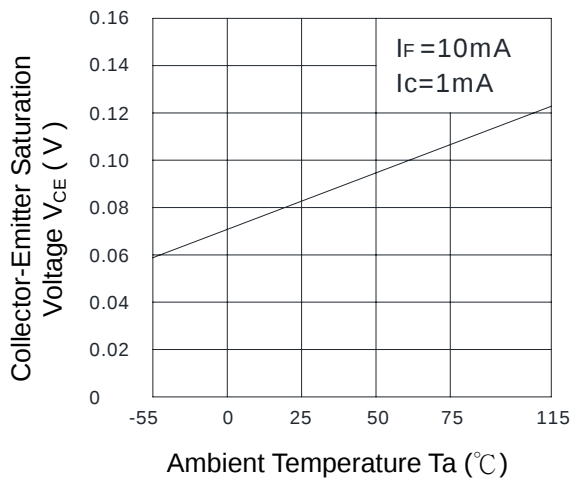


Fig.9 Collector-Emitter Saturation Voltage vs. Forward Current

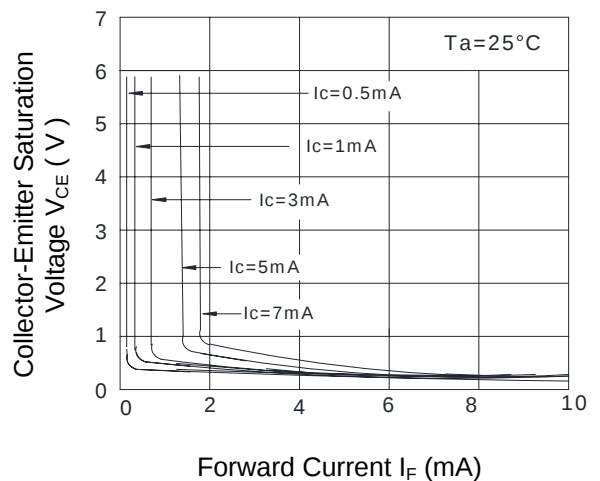


Fig.10 Response Time (Rise) vs. Load Resistance

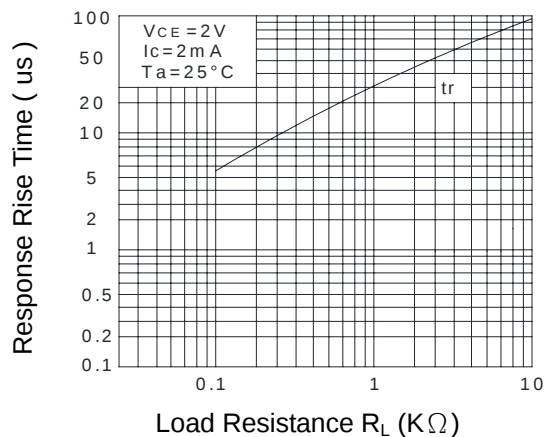
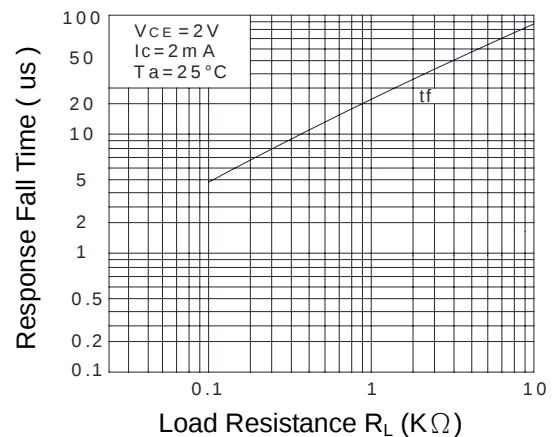
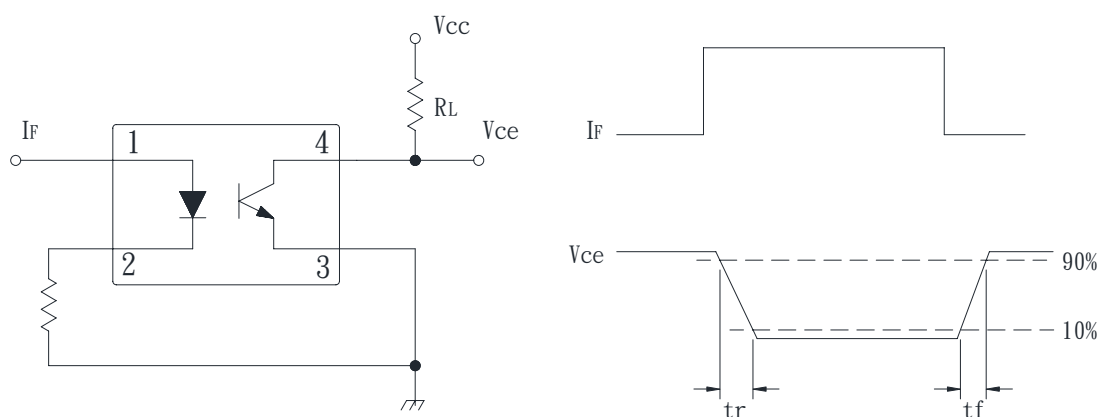


Fig.11 Response Time (Fall) vs. Load Resistance



● Test Circuit for Response Time

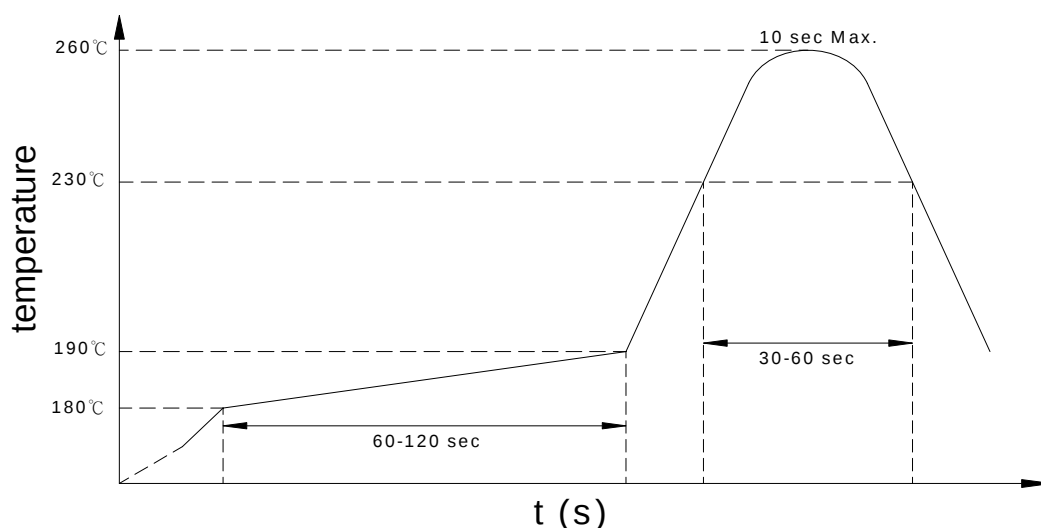


● Recommended Soldering Conditions

(a) Infrared reflow soldering :

- Peak reflow soldering : 260°C or below (package surface temperature)
- Time of peak reflow temperature : 10 sec
- Time of temperature higher than 230°C : 30-60 sec
- Time to preheat temperature from 180~190°C : 60-120 sec
- Time(s) of reflow : Two
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(b) Wave soldering :

- Temperature : 260°C or below (molten solder temperature)
- Time : 10 seconds or less
- Preheating conditions : 120°C or below (package surface temperature)
- Time(s) of reflow : One
- Flux : Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(c) Cautions :

- Fluxes : Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.
- Avoid shorting between portion of frame and leads.

● Numbering System

KT101T Y (Z)

Notes:

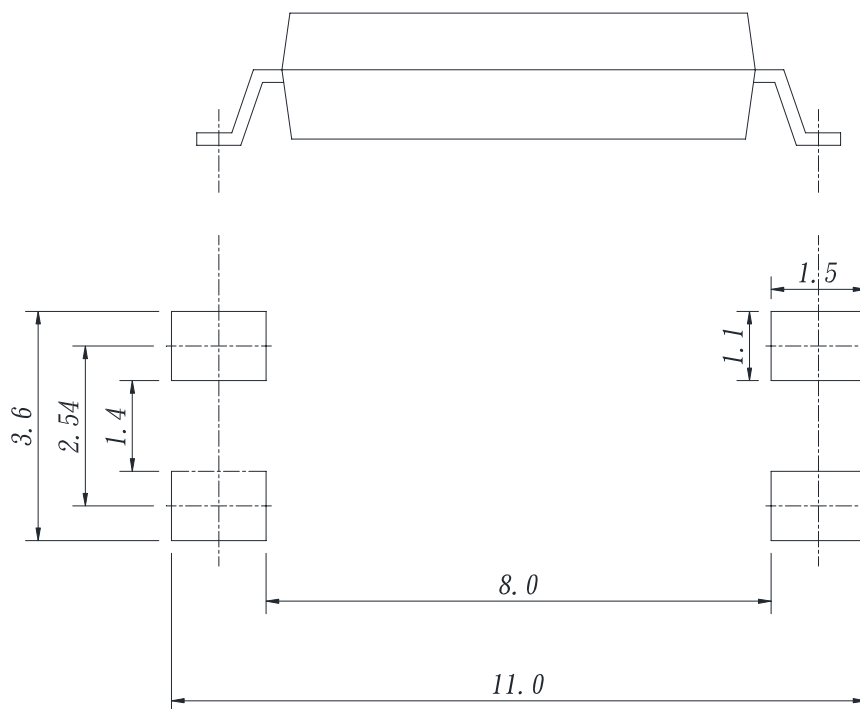
KT101T = Part No.

Y = CTR rank option (A ~ B)

Z = Tape and reel option (TLD 、 TRU)

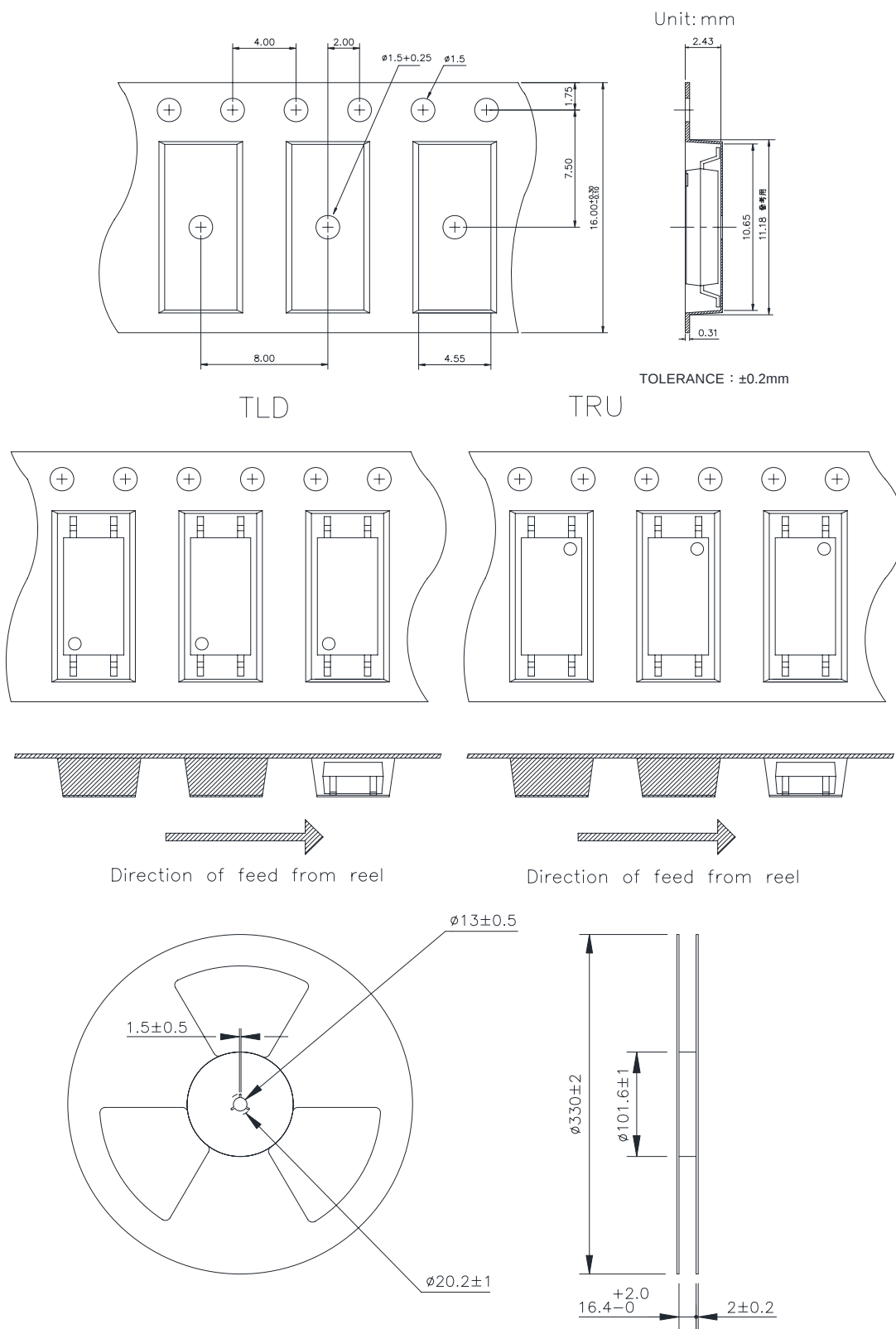
Option	Description	Packing quantity
TLD	TLD tape & reel option	3000 units per reel
TRU	TRU tape & reel option	3000 units per reel

● Recommended Pad Layout for Surface Mount Lead Form



Unit : mm

● 4-pin LSOP Carrier Tape & Reel



● Application Notice

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- c. Audio / Video
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- e. Electrical application
- f. Measurement equipment
- g. Consumer electronics
- h. Telecommunication

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- b. Space application
- c. Telecommunication equipment (trunk lines)
- d. Nuclear power control
- e. Equipment used for automotive vehicles, trains, ships...etc.

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